

# 1.5V Drive Pch MOSFET

# RT1A045AP

#### Structure

Silicon P-channel MOSFET

#### ● Features

- 1) Low On-resistance.
- 2) Small high power package.
- 3) Low voltage drive.(1.5V)

# Application

Switching

Packaging specifications

Type	Package	Taping	
	Code	TR	
	Basic ordering unit (pieces)	3000	
RT1A045AP		0	

# ● Absolute maximum ratings (Ta = 25°C)

Parame	Symbol	Limits	Unit	
Drain-source voltage		$V_{DSS}$	-12	V
Gate-source voltage		$V_{GSS}$	0 to -8	V
Drain current	Continuous	$I_D$	±4.5	Α
	Pulsed	I <sub>DP</sub> *1	±18	Α
Source current	Continuous	I <sub>S</sub>	-1	Α
(Body Diode)	Pulsed	I <sub>SP</sub> *1	-18	Α
Power dissipation		P <sub>D</sub> *2	1.25	W
Channel temperature		Tch	150	°C
Range of storage temperature		Tstg	-55 to +150	°C

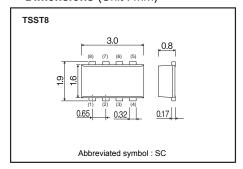
<sup>\*1</sup> Pw $\leq$ 10 $\mu$ s, Duty cycle $\leq$ 1%

#### • Thermal resistance

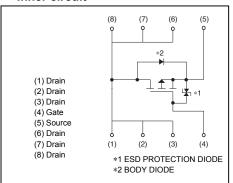
Parameter	Symbol	Limits	Unit
Channel to Ambient	Rth (ch-a)*	100	°C/W

<sup>\*</sup>Mounted on a ceramic board.

#### • Dimensions (Unit : mm)



#### • Inner circuit



<sup>\*2</sup> Mounted on a ceramic board.

# ● Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	$I_{GSS}$	i	-	-10	μΑ	$V_{GS}$ =-8V, $V_{DS}$ =0V
Drain-source breakdown voltage	$V_{(BR)DSS}$	-12	-	-	٧	I <sub>D</sub> =-1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	I <sub>DSS</sub>	1	-	-10	μΑ	$V_{DS}$ =-12V, $V_{GS}$ =0V
Gate threshold voltage	V <sub>GS (th)</sub>	-0.3	-	-1.0	<b>V</b>	$V_{DS}$ =-6V, $I_{D}$ =-1mA
		1	22	30		I <sub>D</sub> =-4.5A, V <sub>GS</sub> =-4.5V
Static drain-source on-state	P *	ı	28	39	mΩ	I <sub>D</sub> =-2.2A, V <sub>GS</sub> =-2.5V
resistance	R <sub>DS (on)</sub>	i	38	57	11112	I <sub>D</sub> =-2.2A, V <sub>GS</sub> =-1.8V
		i	50	100		I <sub>D</sub> =-0.9A, V <sub>GS</sub> =-1.5V
Forward transfer admittance	IY <sub>fs</sub> I*	5.5	-	-	S	I <sub>D</sub> =-4.5A, V <sub>DS</sub> =-6V
Input capacitance	C <sub>iss</sub>	i	4200	-	pF	V <sub>DS</sub> =-6V
Output capacitance	C <sub>oss</sub>	-	350	-	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	$C_{rss}$	-	330	-	pF	f=1MHz
Turn-on delay time	t <sub>d(on)</sub> *	-	16	-	ns	I <sub>D</sub> =-2.2A, V <sub>DD</sub> ≒-6V
Rise time	t <sub>r</sub> *	-	60	-	ns	V <sub>GS</sub> =-4.5V
Turn-off delay time	t <sub>d(off)</sub> *	-	400	-	ns	$R_L$ =2.7 $\Omega$
Fall time	t <sub>f</sub> *	-	150	-	ns	$R_G$ =10 $\Omega$
Total gate charge	Q <sub>g</sub> *	-	40	_	nC	I <sub>D</sub> =-4.5A
Gate-source charge	Q <sub>gs</sub> *	TR	6.5	-	nC	V <sub>DD</sub> ≒-6V
Gate-drain charge	Q <sub>gd</sub> *	3000	6.0	-	nC	V <sub>GS</sub> =-4.5V

<sup>\*</sup>Pulsed

# ●Body diode characteristics (Source-Drain) (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward Voltage	V <sub>SD</sub> *	-	-	-1.2	V	I <sub>s</sub> =-4.5A, V <sub>GS</sub> =0V

<sup>\*</sup>Pulsed

# ●Electrical characteristic curves (Ta=25°C)

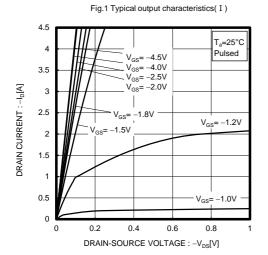


Fig.3 Typical Transfer Characteristics

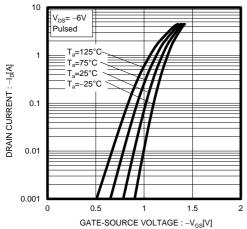
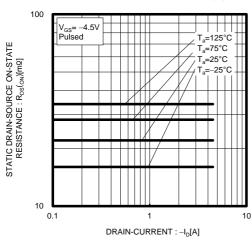
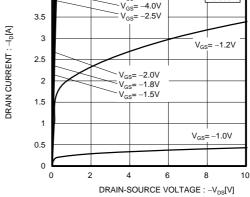


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current( II )



T<sub>a</sub>=25°C  $V_{GS} = -4.5V$  $V_{GS} = -4.0V$ Pulsed V<sub>GS</sub>= -2.5V 3 V<sub>GS</sub>= -1.2V V<sub>GS</sub>= -2.0V

Fig.2 Typical output characteristics( II )



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Fig.4 Static Drain-Source On-State Resistance vs. Drain Current( I )

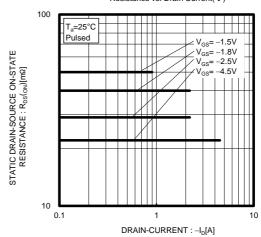
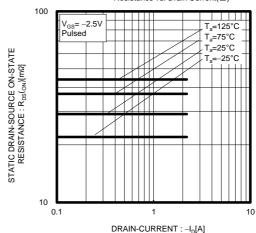
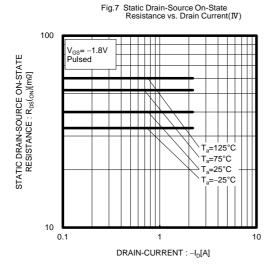
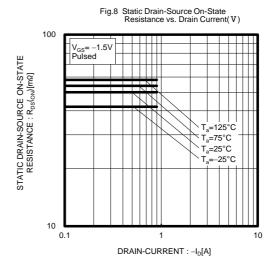
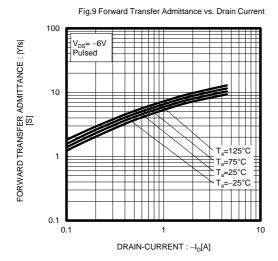


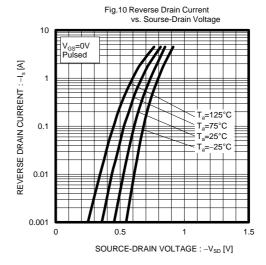
Fig.6 Static Drain-Source On-State Resistance vs. Drain Current(Ⅲ)

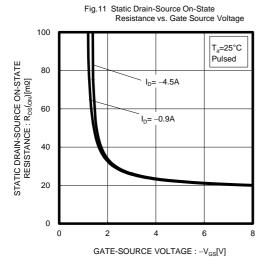


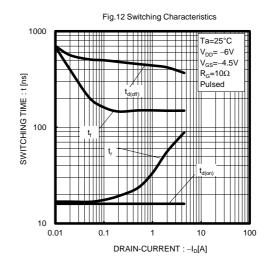


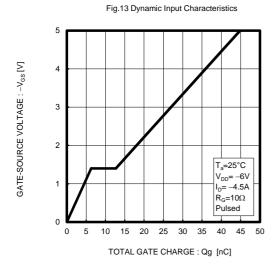


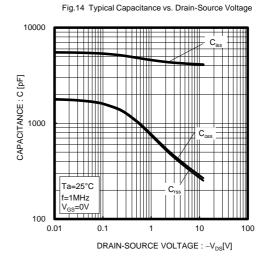












# Measurement circuits

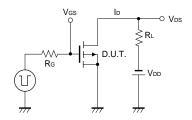


Fig.1-1 Switching Time Measurement Circuit

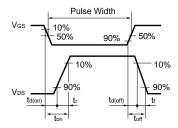


Fig.1-2 Switching Waveforms

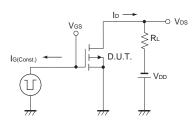


Fig.2-1 Gate Charge Measurement Circuit

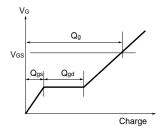


Fig.2-2 Gate Charge Waveform

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6/6

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